



Schottky Diodes

Features

- High frequency operation
- Low forward voltage drop
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- Guard ring for enhanced ruggedness and long term reliability
- Solder dip 275 °C max. 7 s, per JESD 22-B106

Typical Applications

Typical applications are in switching power supplies, converters, freewheeling diodes, and reverse battery protection.

Mechanical Data

Package: ITO-220AB

Molding compound meets UL 94 V-0 flammability rating, RoHS-compliant

Terminals: Tin plated leads, solderable per J-STD-

MBR1080FCTA THRU MBR10200FCTA



